

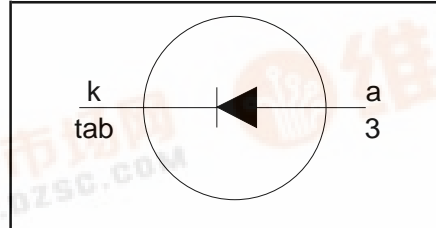
**Rectifier diode
ultrafast, low switching loss**

BYC10B-600

FEATURES

- Extremely fast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET

SYMBOL



QUICK REFERENCE DATA

$V_R = 600\text{ V}$
$V_F \leq 1.8\text{ V}$
$I_{F(AV)} = 10\text{ A}$
$t_{rr} = 19\text{ ns (typ)}$

APPLICATIONS

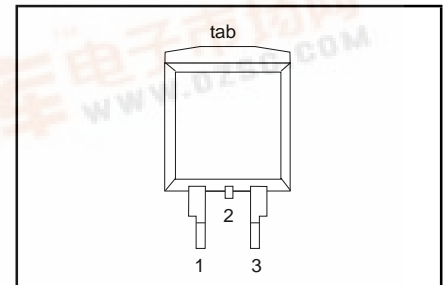
- Active power factor correction
- Half-bridge lighting ballasts
- Half-bridge/ full-bridge switched mode power supplies.

The BYC10B-600 is supplied in the SOT404 surface mounting package.

PINNING

PIN	DESCRIPTION
1	no connection
2	cathode ¹
3	anode
tab	cathode

SOT404



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	Peak repetitive reverse voltage		-	600	V
V_{RWM}	Crest working reverse voltage		-	600	V
V_R	Continuous reverse voltage	$T_{mb} \leq 114\text{ °C}$	-	500	V
$I_{F(AV)}$	Average forward current	$\delta = 0.5$; with reapplied $V_{RRM(max)}$; $T_{mb} \leq 78\text{ °C}$	-	10	A
I_{FRM}	Repetitive peak forward current	$\delta = 0.5$; with reapplied $V_{RRM(max)}$; $T_{mb} \leq 78\text{ °C}$	-	20	A
I_{FSM}	Non-repetitive peak forward current.	$t = 10\text{ ms}$ $t = 8.3\text{ ms}$ sinusoidal; $T_j = 150\text{ °C}$ prior to surge with reapplied $V_{RWM(max)}$	-	65 71	A A
T_{stg}	Storage temperature		-40	150	°C
T_j	Operating junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	-	2	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	minimum footprint, FR4 board	-	50	-	K/W

¹ it is not possible to make connection to pin 2 of the SOT404 package



Rectifier diode

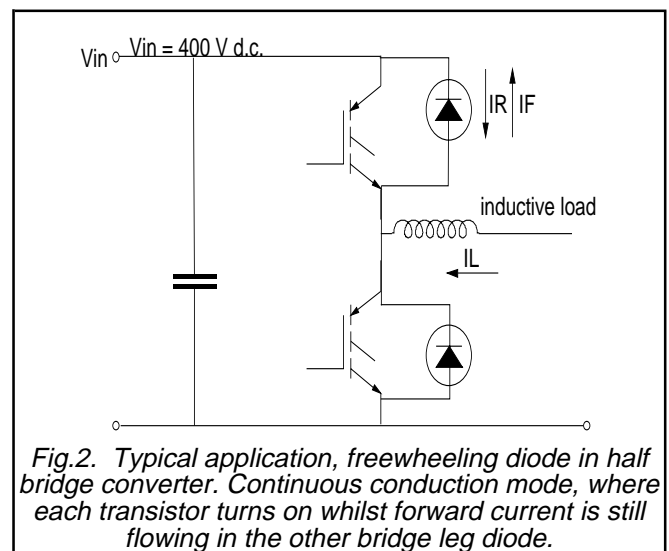
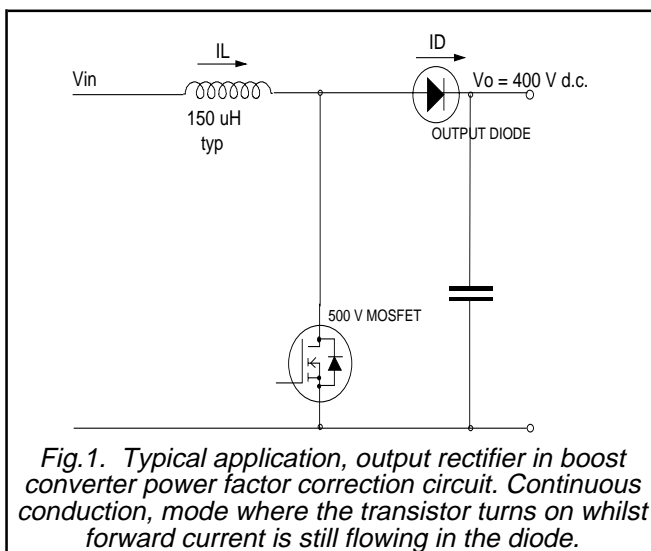
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ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	Forward voltage	$I_F = 10\text{ A}; T_j = 150\text{ }^\circ\text{C}$ $I_F = 20\text{ A}; T_j = 150\text{ }^\circ\text{C}$ $I_F = 10\text{ A};$	-	1.4 1.7 2.0	1.8 2.3 2.8	V V V
I_R	Reverse current	$V_R = 600\text{ V}$ $V_R = 500\text{ V}; T_j = 100\text{ }^\circ\text{C}$	-	9 1.1	200 3.0	μA mA
t_{rr}	Reverse recovery time	$I_F = 1\text{ A}; V_R = 30\text{ V}; dI_F/dt = 50\text{ A}/\mu\text{s}$	-	35	55	ns
t_{rr}	Reverse recovery time	$I_F = 10\text{ A}; V_R = 400\text{ V};$ $dI_F/dt = 500\text{ A}/\mu\text{s}$	-	19	-	ns
t_{rr}	Reverse recovery time	$I_F = 10\text{ A}; V_R = 400\text{ V};$ $dI_F/dt = 500\text{ A}/\mu\text{s}; T_j = 125\text{ }^\circ\text{C}$	-	32	40	ns
I_{rrm}	Peak reverse recovery current	$I_F = 10\text{ A}; V_R = 400\text{ V};$ $dI_F/dt = 100\text{ A}/\mu\text{s}; T_j = 125\text{ }^\circ\text{C}$	-	3	7.5	A
I_{rrm}	Peak reverse recovery current	$I_F = 10\text{ A}; V_R = 400\text{ V};$ $dI_F/dt = 500\text{ A}/\mu\text{s}; T_j = 125\text{ }^\circ\text{C}$	-	9.5	12	A
V_{fr}	Forward recovery voltage	$I_F = 10\text{ A}; dI_F/dt = 100\text{ A}/\mu\text{s}$	-	8	11	V



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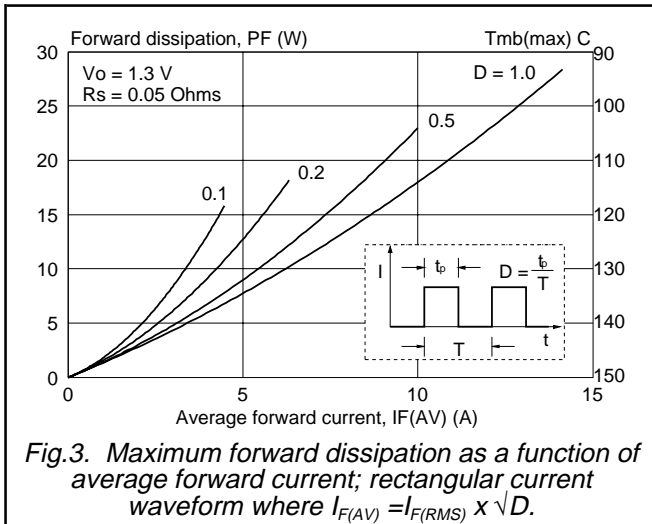


Fig.3. Maximum forward dissipation as a function of average forward current; rectangular current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

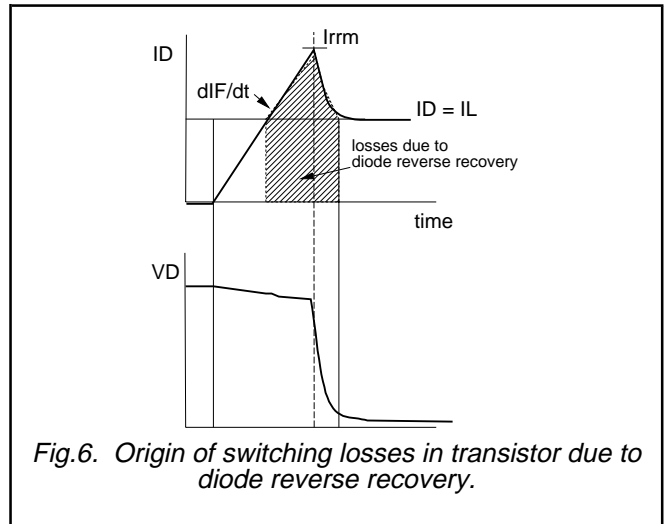


Fig.6. Origin of switching losses in transistor due to diode reverse recovery.

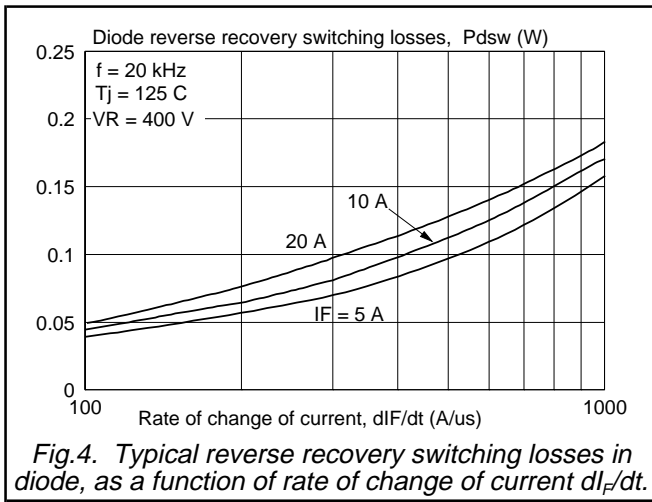


Fig.4. Typical reverse recovery switching losses in diode, as a function of rate of change of current dI_F/dt .

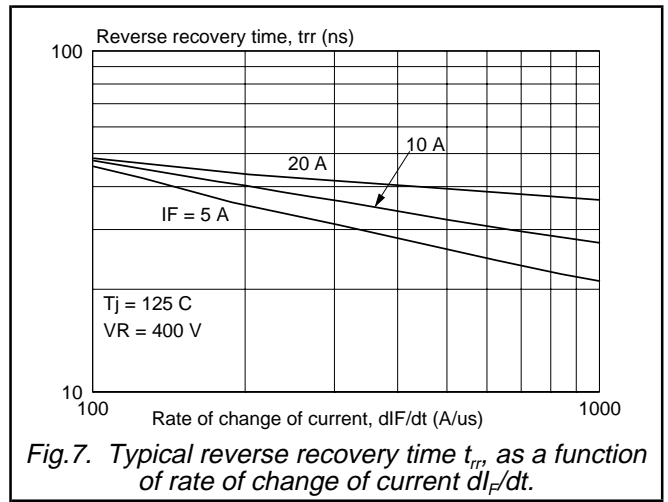


Fig.7. Typical reverse recovery time t_{rr} , as a function of rate of change of current dI_F/dt .

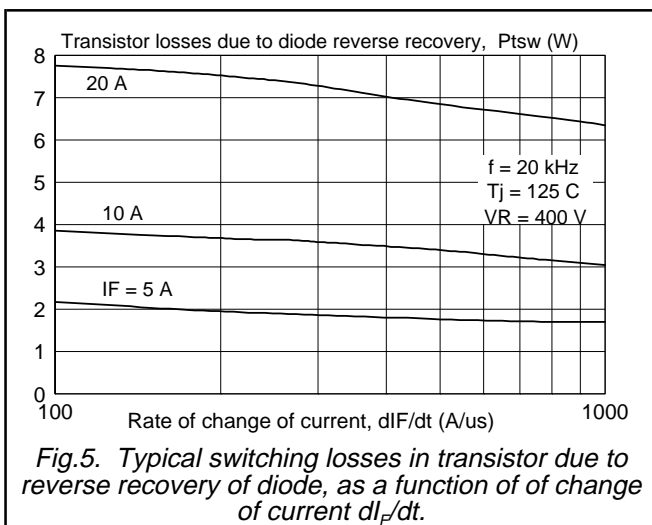


Fig.5. Typical switching losses in transistor due to reverse recovery of diode, as a function of change of current dI_F/dt .

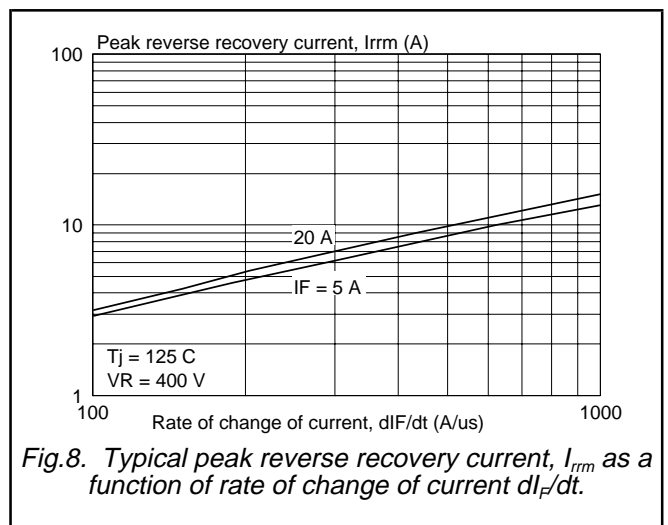


Fig.8. Typical peak reverse recovery current, I_{rrm} , as a function of rate of change of current dI_F/dt .

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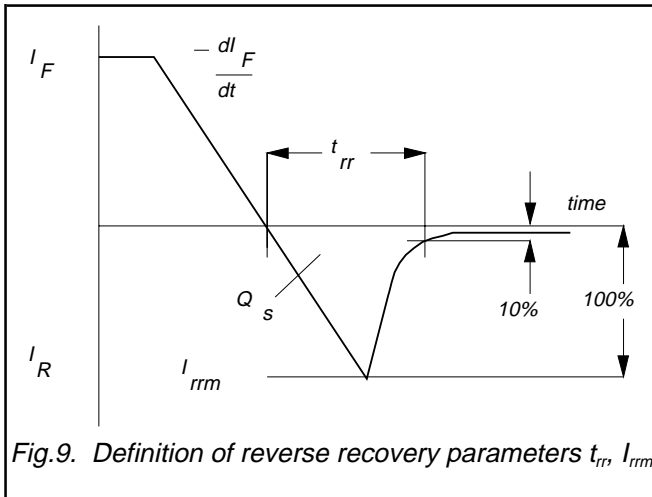


Fig.9. Definition of reverse recovery parameters t_{rr} , I_{rrm}

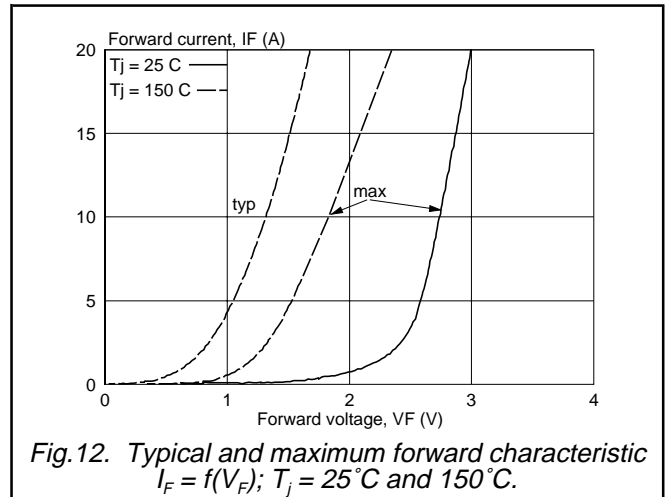


Fig.12. Typical and maximum forward characteristic $I_F = f(V_F)$; $T_J = 25^\circ\text{C}$ and 150°C .

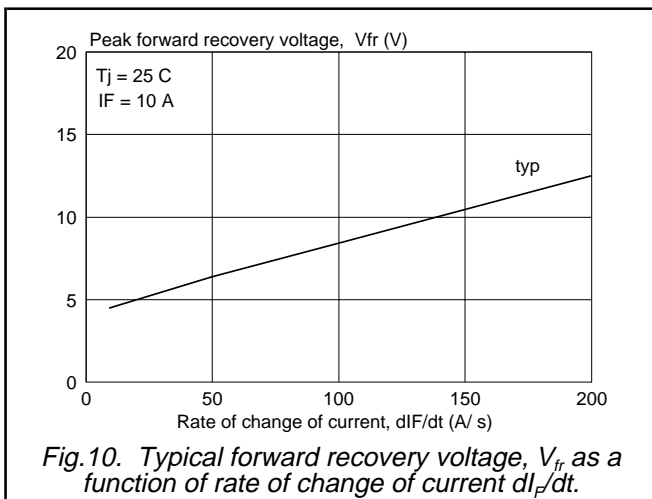


Fig.10. Typical forward recovery voltage V_{fr} as a function of rate of change of current dI_F/dt .

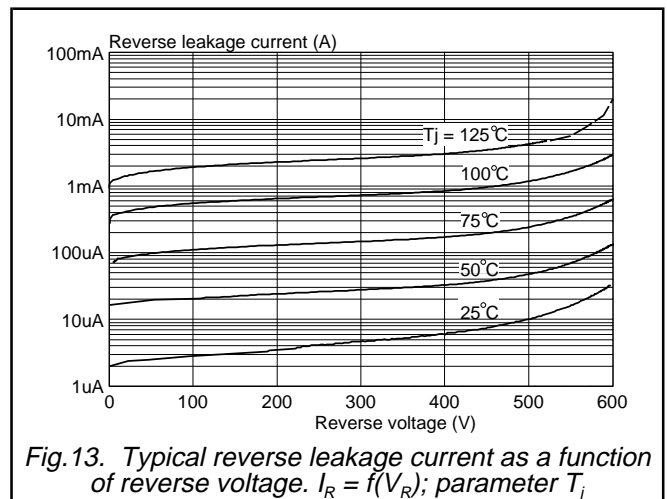


Fig.13. Typical reverse leakage current as a function of reverse voltage. $I_R = f(V_R)$; parameter T_J

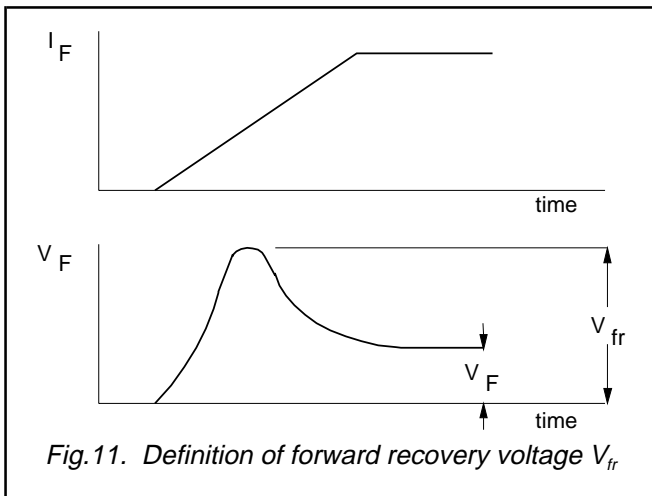


Fig.11. Definition of forward recovery voltage V_{fr}

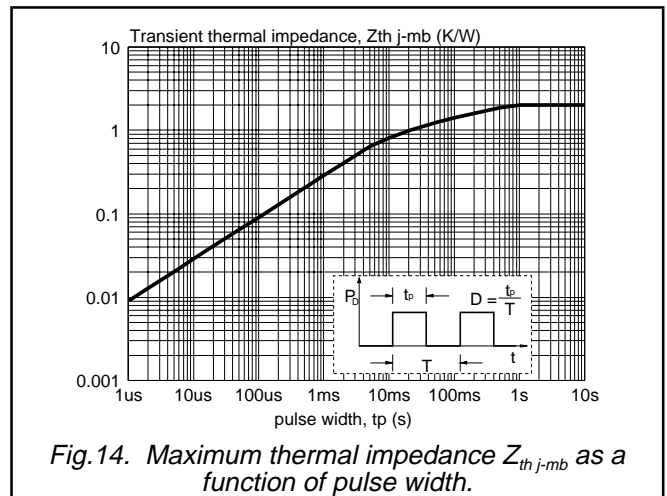
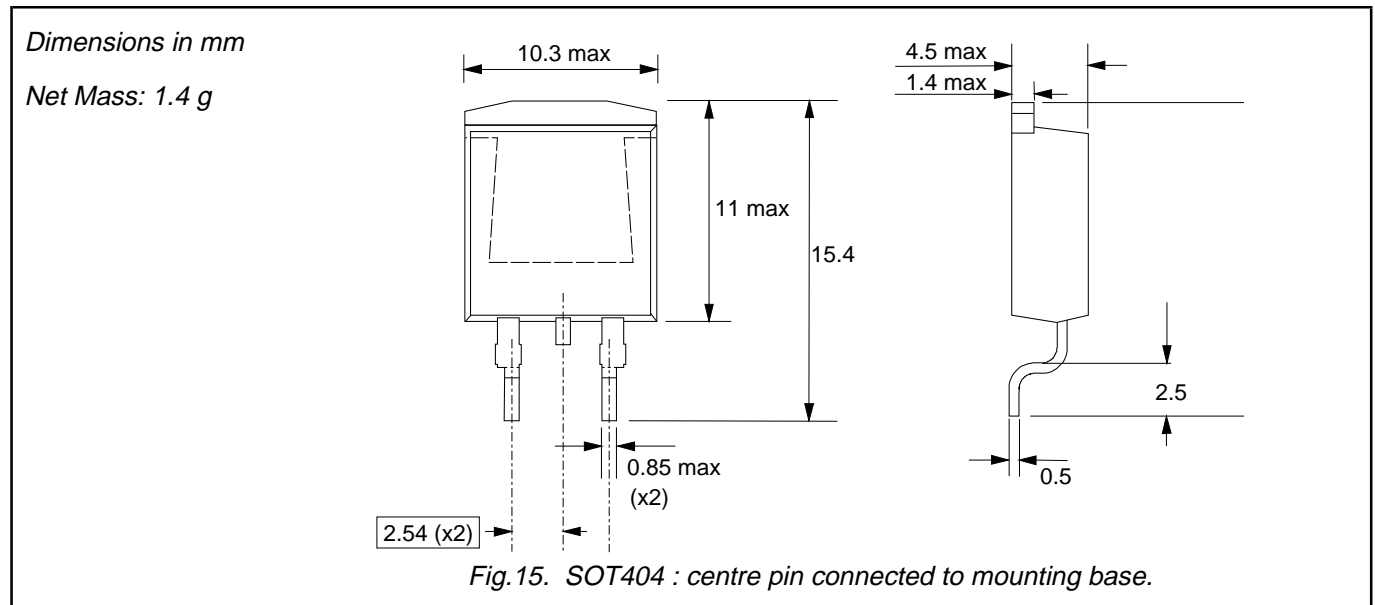


Fig.14. Maximum thermal impedance $Z_{th j-mb}$ as a function of pulse width.

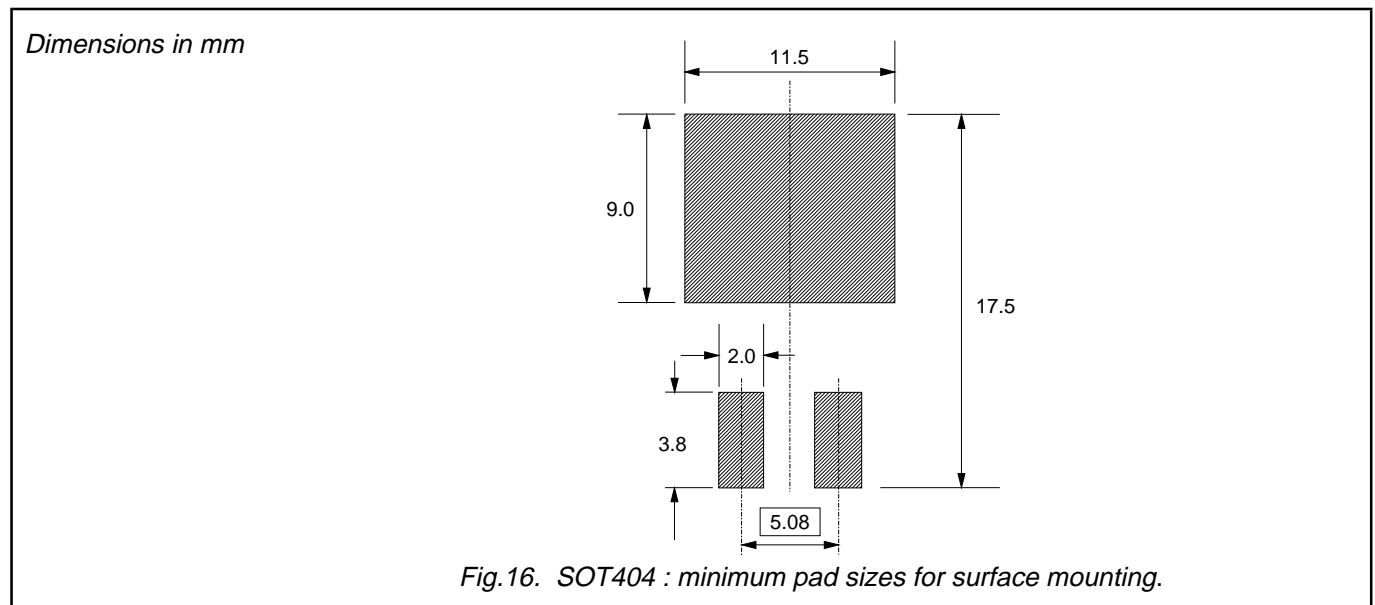
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MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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